

N32G457xC/xE

Product Brief

N32G457 series uses a 32-bit ARM Cortex-M4 core with a maximum operating frequency of 144MHz, supporting floating point unit and DSP instructions, integrating up to 512KB Flash, 144KB SRAM, and built-in four 12bit 5Msps ADC, four independent rail-to-rail operational amplifiers, seven high-speed comparators, two 1Msps 12bit DAC, integrated multi-channel U(S)ART, I2C, SPI, QSPI, USB, CAN, SDIO communication interface, 10/100M ethernet network and digital camera interface, Built-in cryptographic algorithm hardware acceleration engine

Main Features

- **CPU Core**
 - 32-bit ARM Cortex-M4 core + FPU, single-cycle hardware multiply and divide instructions, support DSP instructions and MPU
 - Built-in 8KB instruction Cache, support Flash acceleration unit execution program 0 wait
 - Run up to 144MHz, 180DMIPS
- **Memories**
 - Up to 512KByte embedded Flash memory, support encrypted storage, partition management and data protection, support hardware ECC verification, 100,000 erasing times, 10 years data retention
 - 144KByte embedded SRAM (including 16KByte Retention RAM), supporting hardware parity check
- **Communication Interface**
 - 7x U(S)ART interfaces with speeds up to 4.5Mbps, including 3x USART interfaces (supporting ISO7816, IrDA, LIN) and 4x UART interfaces
 - 3x SPI interfaces with speeds up to 36MHz, two of which support I2S
 - 1x QSPI interface with speeds up to 144Mbps
 - 4x I2C interfaces with speeds up to 1MHz, which can be configured in master/slave mode and support dual address response in slave mode
 - 1x USB2.0 Full Speed Device port
 - 2x CAN 2.0B bus interfaces
 - 1x SDIO interface, supporting SD/MMC format
 - 1x Ethernet interface, supporting 10M/100M Ethernet
 - 1x DVP (Digital Video Port)
- **High-performance Analog Interface**
 - 4x 12bit 5Msps high-speed ADCs, available in 12/10/8/6 bit mode, sampling rate up to 9Msps in 6bit mode and up to 40 external single-ended input channels, supporting differential mode
 - 4x rail-to-rail operational amplifiers with built-in programmable gain amplification up to 32 times
 - Up to 7x high-speed analog comparators with built-in 64 level adjustable comparison datum
 - 2x 12bit DAC, sampling rate 1Msps

- Support external input independent reference voltage source
- All analog interfaces support full voltage from 1.8 to 3.6V
- **Clock**
 - 4MHz~32MHz external high-speed crystal
 - 32.768KHz external low-speed crystal
 - Internal high-speed RC 8MHz
 - Internal low-speed RC 40KHz
 - Built-in high-speed PLL
 - Supports one-way clock output, which can be configured with system clock, HSE, HSI, or PLL frequency division output
- **Reset**
 - Supports power on, power down, brown-out, and external pin reset
 - Support watchdog reset, software reset
- **Up to 97 GPIOs with multiplexing function. The maximum flip speed is 50MHz. Most GPIO supports 5V voltage resistance.**
- **2x high-speed DMA controllers, each controller supports 8 channels, channel source address and destination address can be arbitrarily configurable**
- **RTC real-time clock, support leap year perpetual calendar, alarm clock event, periodic wake up, support internal and external clock calibration**
- **Timing Counter**
 - 2x 16bit advanced timer counters, support input capture, complementary output, orthogonal coding input and other functions, the highest control accuracy of 6.9ns;Each timer has four independent channels, three of which support 6 complementary PWM output
 - 4x 16bit general timer counters, each timer has four independent channels, support input capture/output comparison /PWM output
 - 2x 16bit basic timer counters
 - 1x 24bit SysTick
 - 1x 7bit Window Watchdog (WWDG)
 - 1x 12bit Independent Watchdog (IWDG)
- **Programming Mode**
 - Support SWD/JTAG online debugging interface
 - Support UART and USB Bootloader
- **Security Features**
 - Built-in cryptographic algorithm hardware acceleration engine

- Supports AES, DES, SHA and MD5 algorithms
- Flash Storage encryption, Multi-user Partition Management (MMU)
- TRNG true random number generator
- CRC16/32 operation
- Support write protection (WRP), multiple read protection (RDP) levels (L0/L1/L2)
- Support security startup, program encryption download, security updates
- Support clock failure detection, anti-disassembly detection

- **96-bit UID and 128-bit UCID**

- **Operating Conditions**

- Operating voltage range: 1.8V~3.6V
- Operating temperature range: -40°C ~ 105°C
- ESD: ±4KV (HBM model), ±1KV (CDM model)

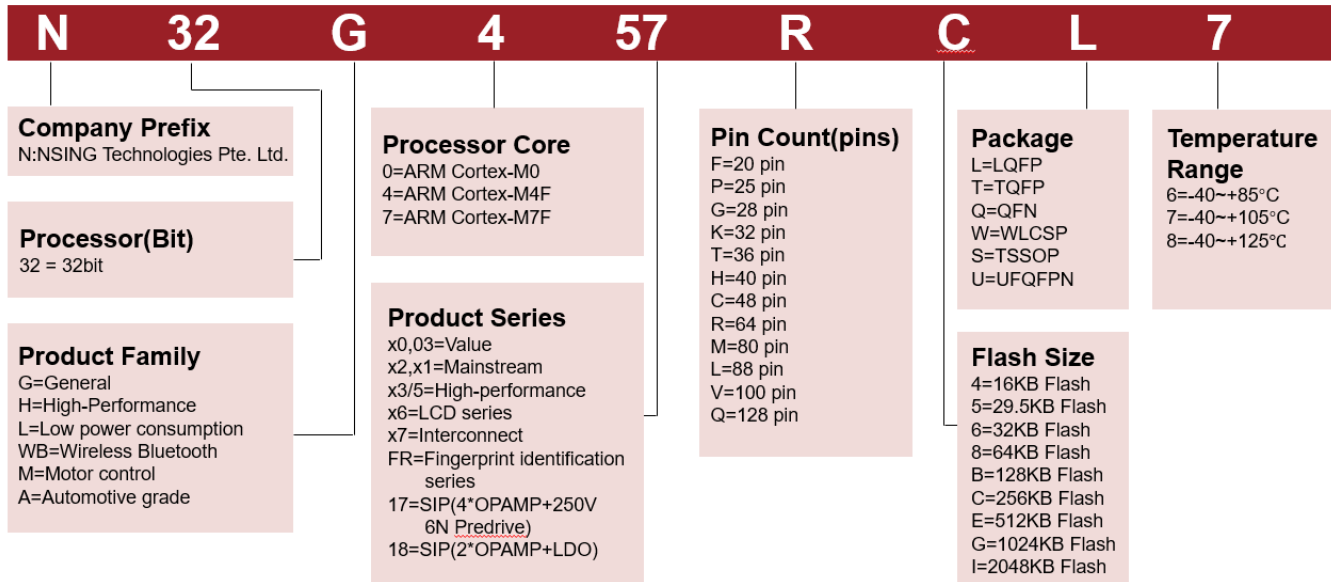
- **Package**

- LQFP64(10mm x 10mm)
- LQFP80(12mm x 12mm)
- LQFP100(14mm x 14mm)
- LQFP128(14mm x 14mm)

- **Order Model**

Series	Model
N32G457xC	N32G457RCL7, N32G457MCL7, N32G457VCL7
N32G457xE	N32G457REL7, N32G457MEL7, N32G457VEL7, N32G457QEL7

1 Naming Convention



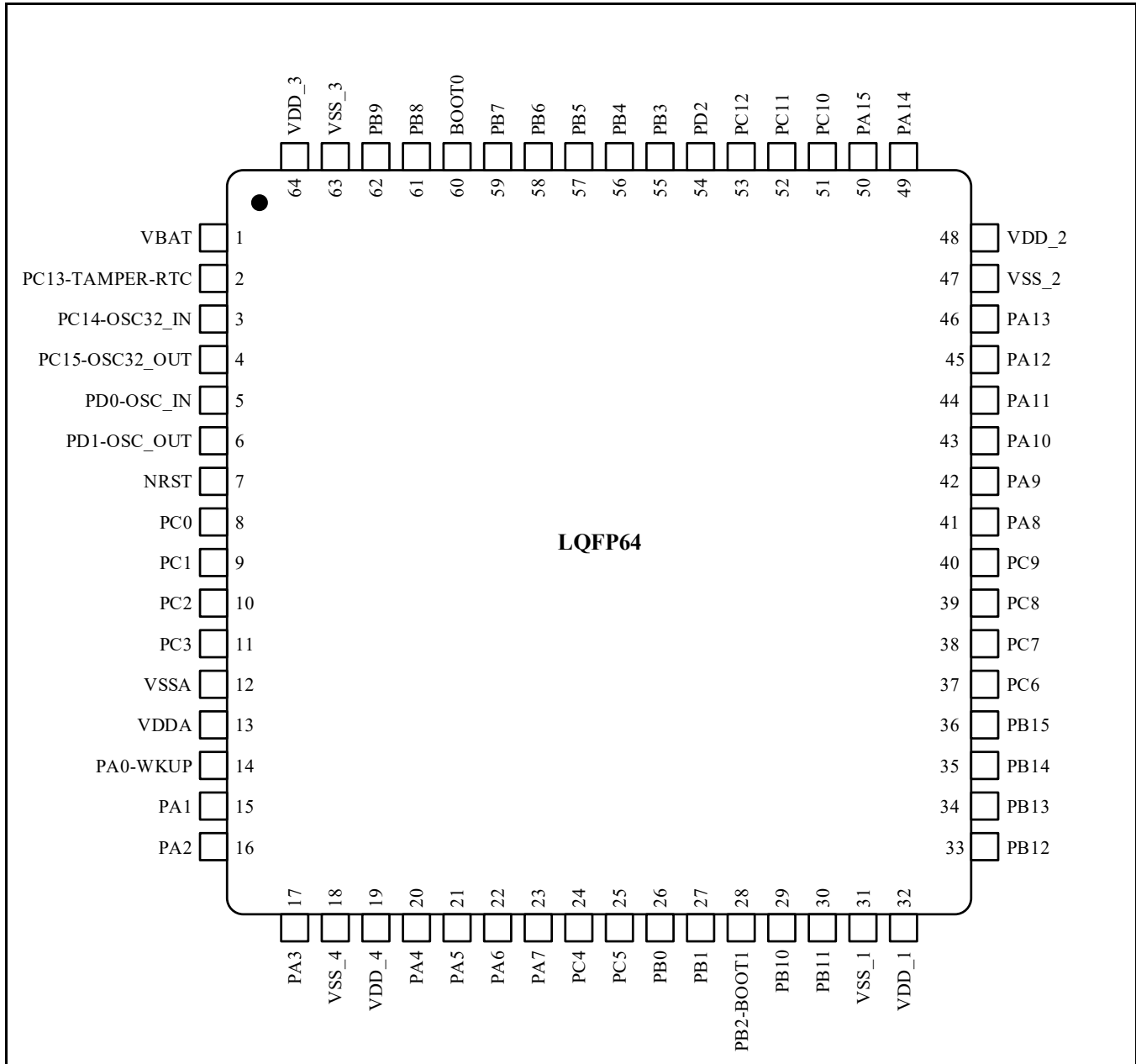
2 Product Configuration

Device type		N32G457RC/E		N32G457MC/E		N32G457VC/E		N32G457QE
Flash size (KB)		256	512	256	512	256	512	512
SRAM size (KB)		144	144	144	144	144	144	144
CPU frequency		ARM Cortex-M4F @144MHz,180DMIPS						
Work environment		1.8~3.6V/-40~105°C						
Timer	General	4						
	Advanced	2						
	Basic	2						
Communication Interface	SPI	3						
	I2S	2						
	QSPI	1						
	I2C	4						
	USART	3						
	UART	4						
	USB	1						
	CAN	2						
	SDIO	1						
	DVP	1						
ETH	1							
GPIO		51		65		80		97
DMA		2						
Number of Channels		16Channel						
12bit ADC		4		4		4		4
Number of channels		22Channel		33 Channel		38Channel		40Channel
12bit DAC		2						
Number of channels		2Channel						
OPA/COMP		4/7						
Algorithm support		DES/3DES、AES、SHA1/SHA224/SHA256,, MD5, CRC16/CRC32, TRNG						
Security protection		Read/write protection (RDP/WRP) , storage encryption, partition protection, secure startup						
Package		LQFP64		LQFP80		LQFP100		LQFP128

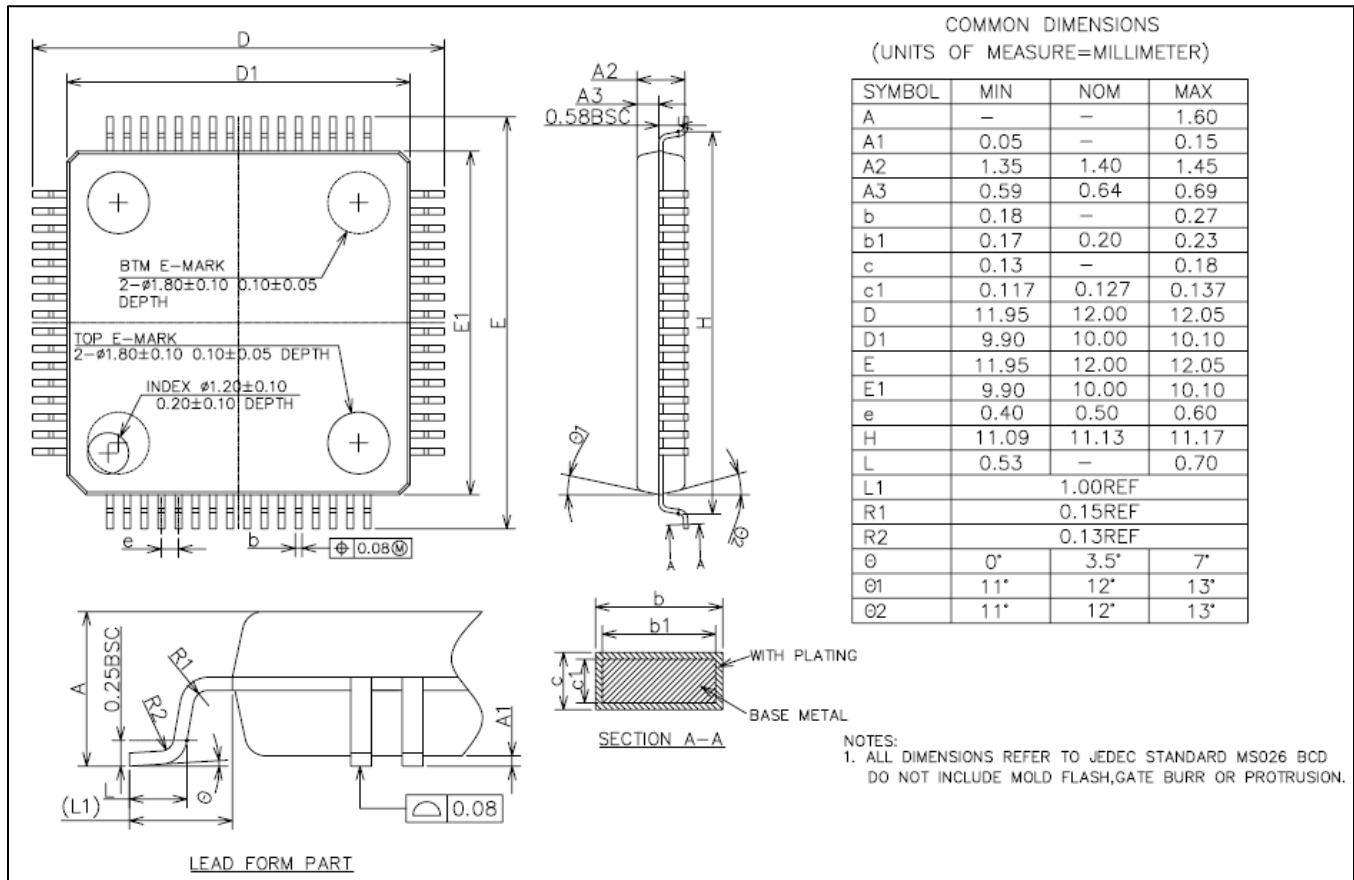
3 Package

3.1 LQFP64 Package

3.1.1 LQFP64 Pin Assignment

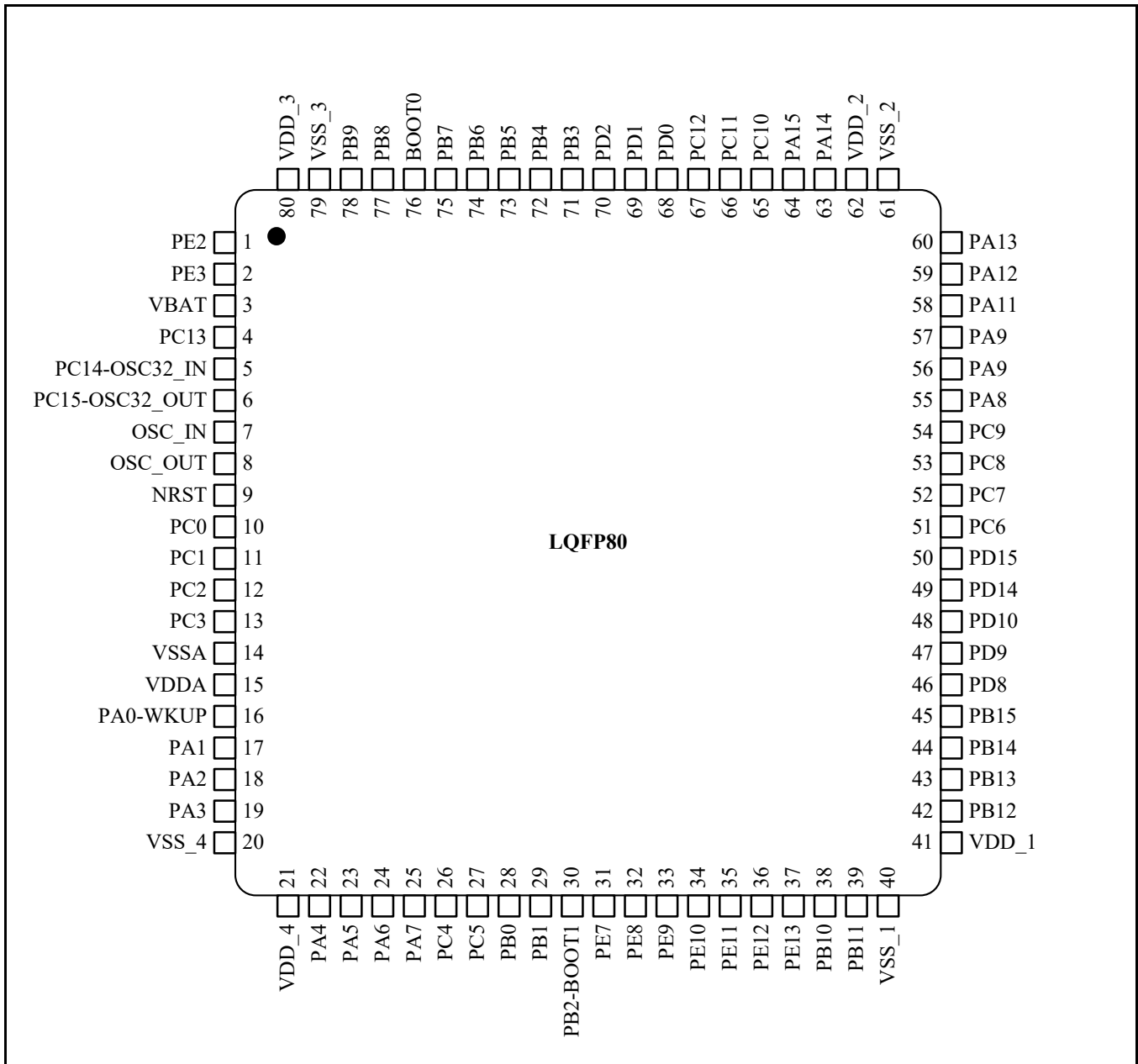


3.1.2 LQFP64 Package Dimensions

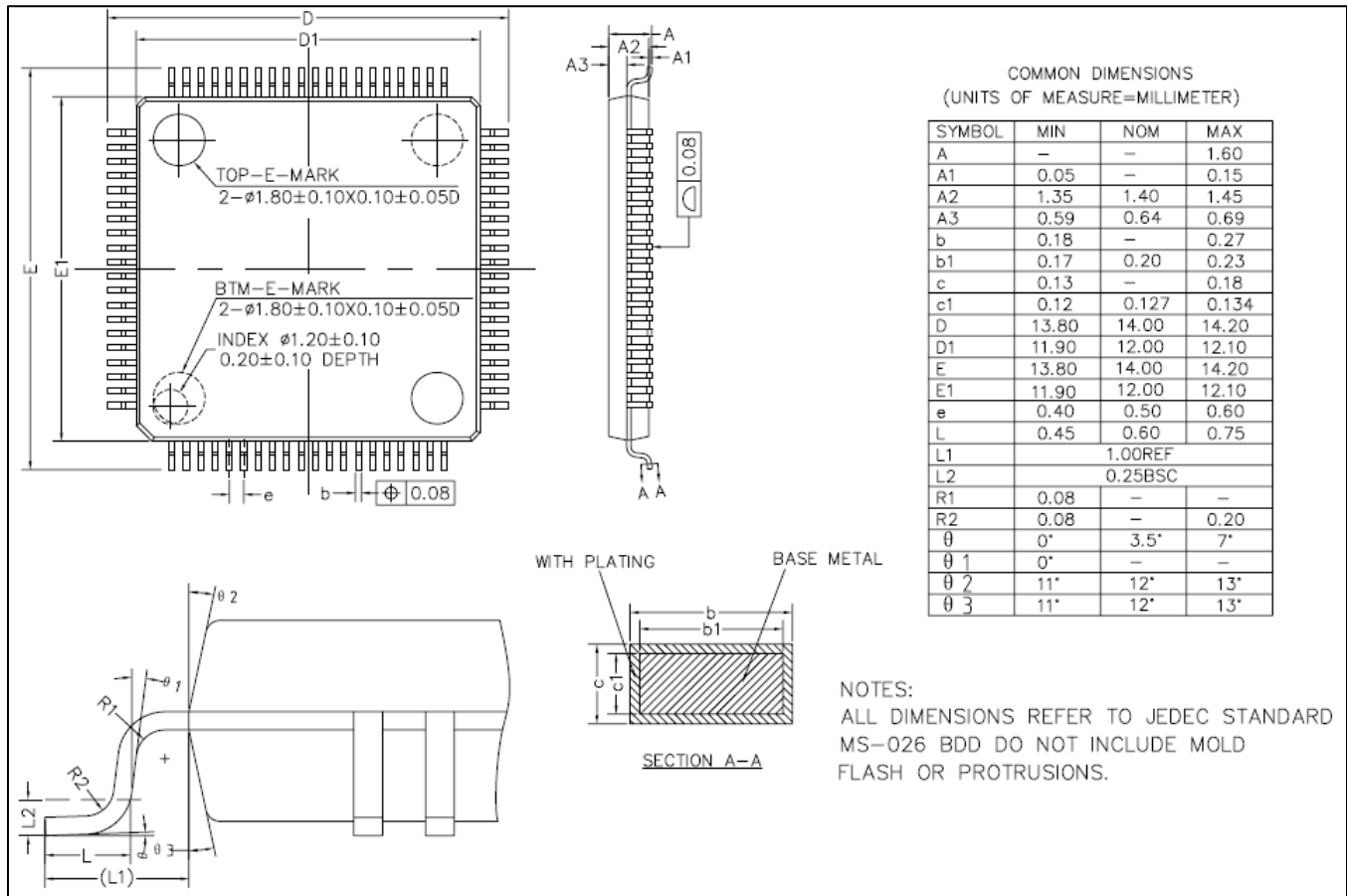


3.2 LQFP80 Package

3.2.1 LQFP80 Pin Assignment



3.2.2 LQFP80 Package Dimensions



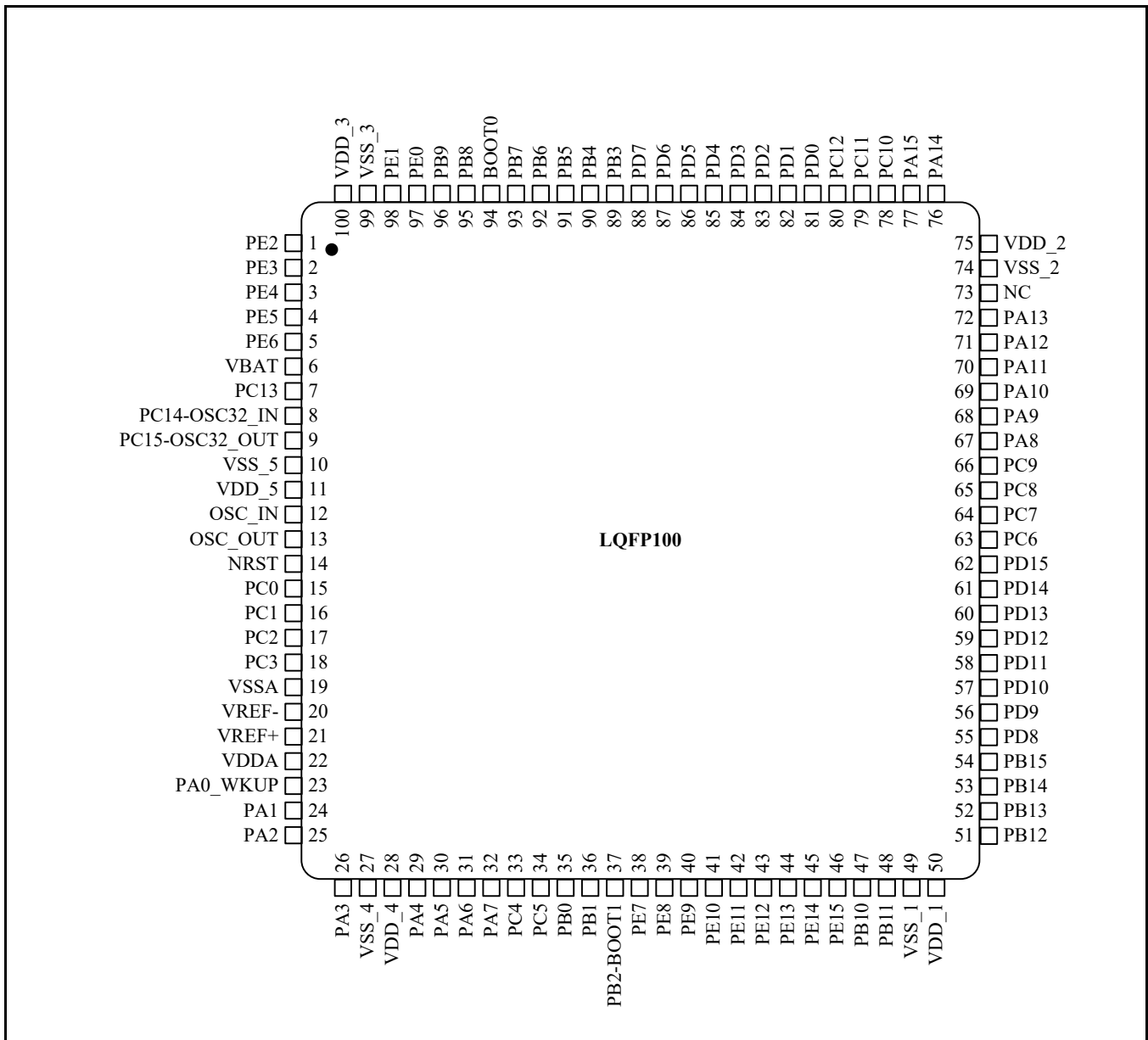
COMMON DIMENSIONS
(UNITS OF MEASURE=MILLIMETER)

SYMBOL	MIN	NOM	MAX
A	—	—	1.60
A1	0.05	—	0.15
A2	1.35	1.40	1.45
A3	0.59	0.64	0.69
b	0.18	—	0.27
b1	0.17	0.20	0.23
c	0.13	—	0.18
c1	0.12	0.127	0.134
D	13.80	14.00	14.20
D1	11.90	12.00	12.10
E	13.80	14.00	14.20
E1	11.90	12.00	12.10
e	0.40	0.50	0.60
L	0.45	0.60	0.75
L1	1.00REF		
L2	0.25BSC		
R1	0.08	—	—
R2	0.08	—	0.20
θ	0°	3.5°	7°
$\theta 1$	0°	—	—
$\theta 2$	11°	12°	13°
$\theta 3$	11°	12°	13°

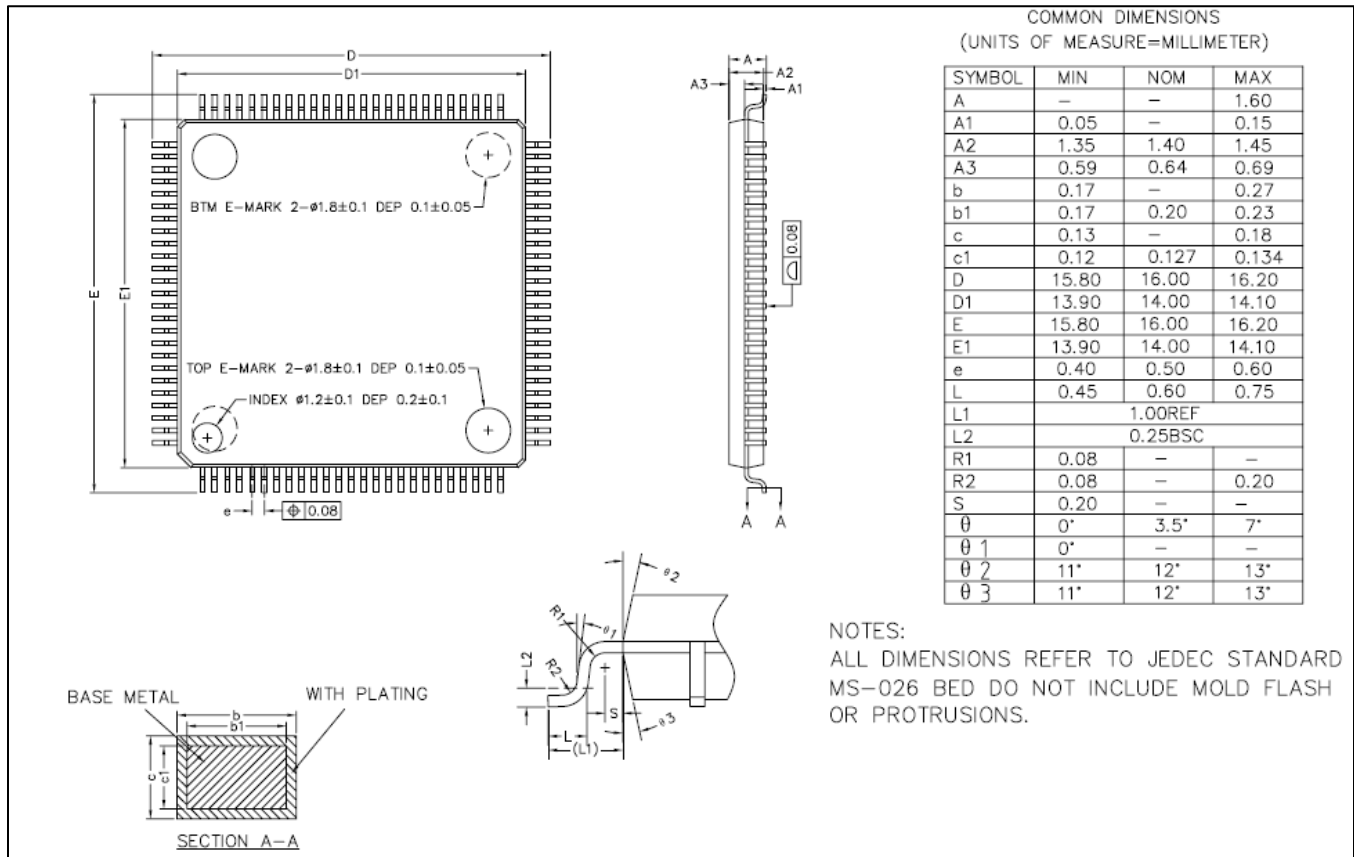
NOTES:
ALL DIMENSIONS REFER TO JEDEC STANDARD MS-026 BDD DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS.

3.3 LQFP100 Package

3.3.1 LQFP100 Pin Assignment



3.3.2 LQFP100 Package Dimensions



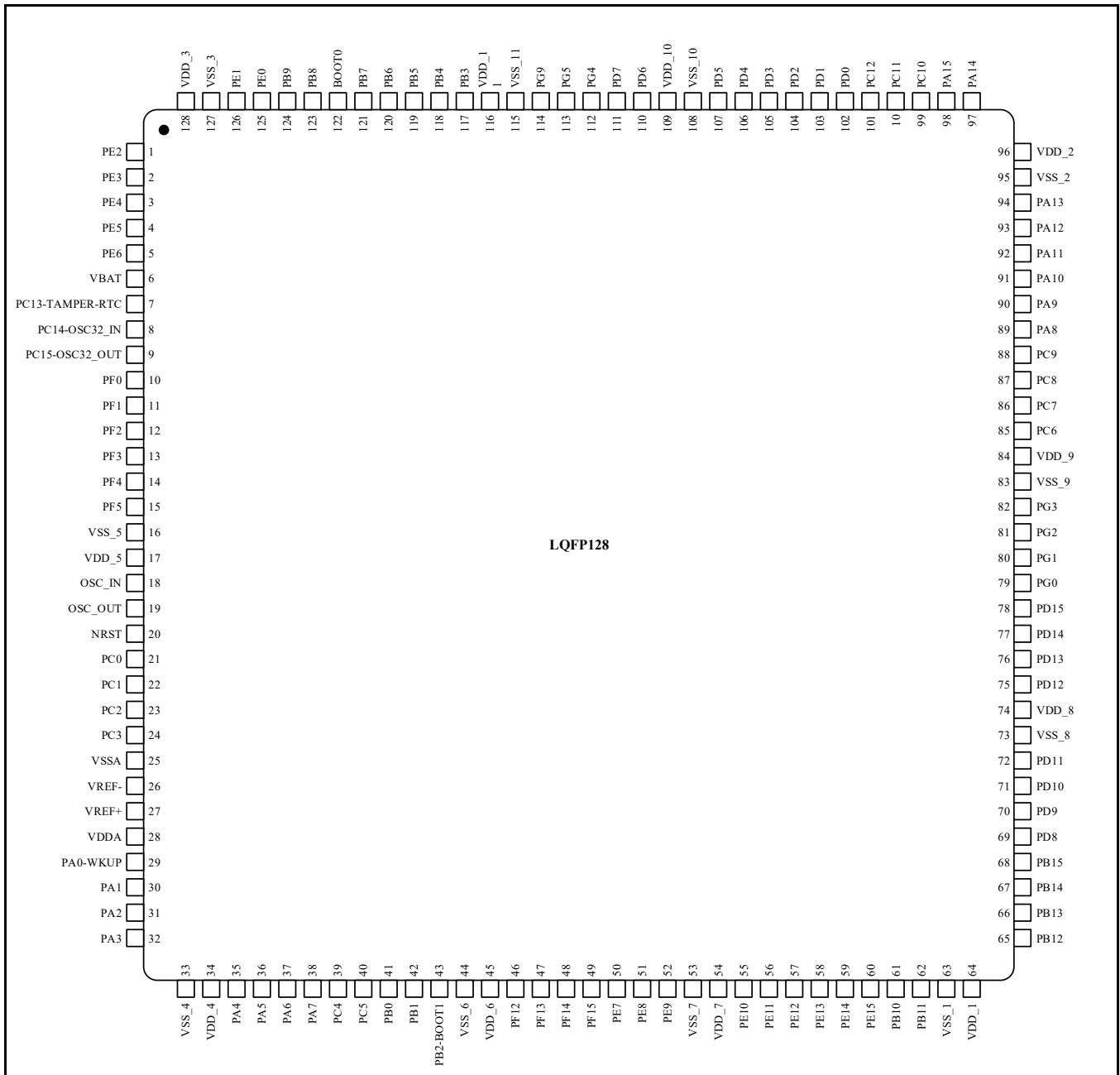
COMMON DIMENSIONS
(UNITS OF MEASURE=MILLIMETER)

SYMBOL	MIN	NOM	MAX
A	—	—	1.60
A1	0.05	—	0.15
A2	1.35	1.40	1.45
A3	0.59	0.64	0.69
b	0.17	—	0.27
b1	0.17	0.20	0.23
c	0.13	—	0.18
c1	0.12	0.127	0.134
D	15.80	16.00	16.20
D1	13.90	14.00	14.10
E	15.80	16.00	16.20
E1	13.90	14.00	14.10
e	0.40	0.50	0.60
L	0.45	0.60	0.75
L1	1.00REF		
L2	0.25BSC		
R1	0.08	—	—
R2	0.08	—	0.20
S	0.20	—	—
θ	0°	3.5°	7°
θ 1	0°	—	—
θ 2	11°	12°	13°
θ 3	11°	12°	13°

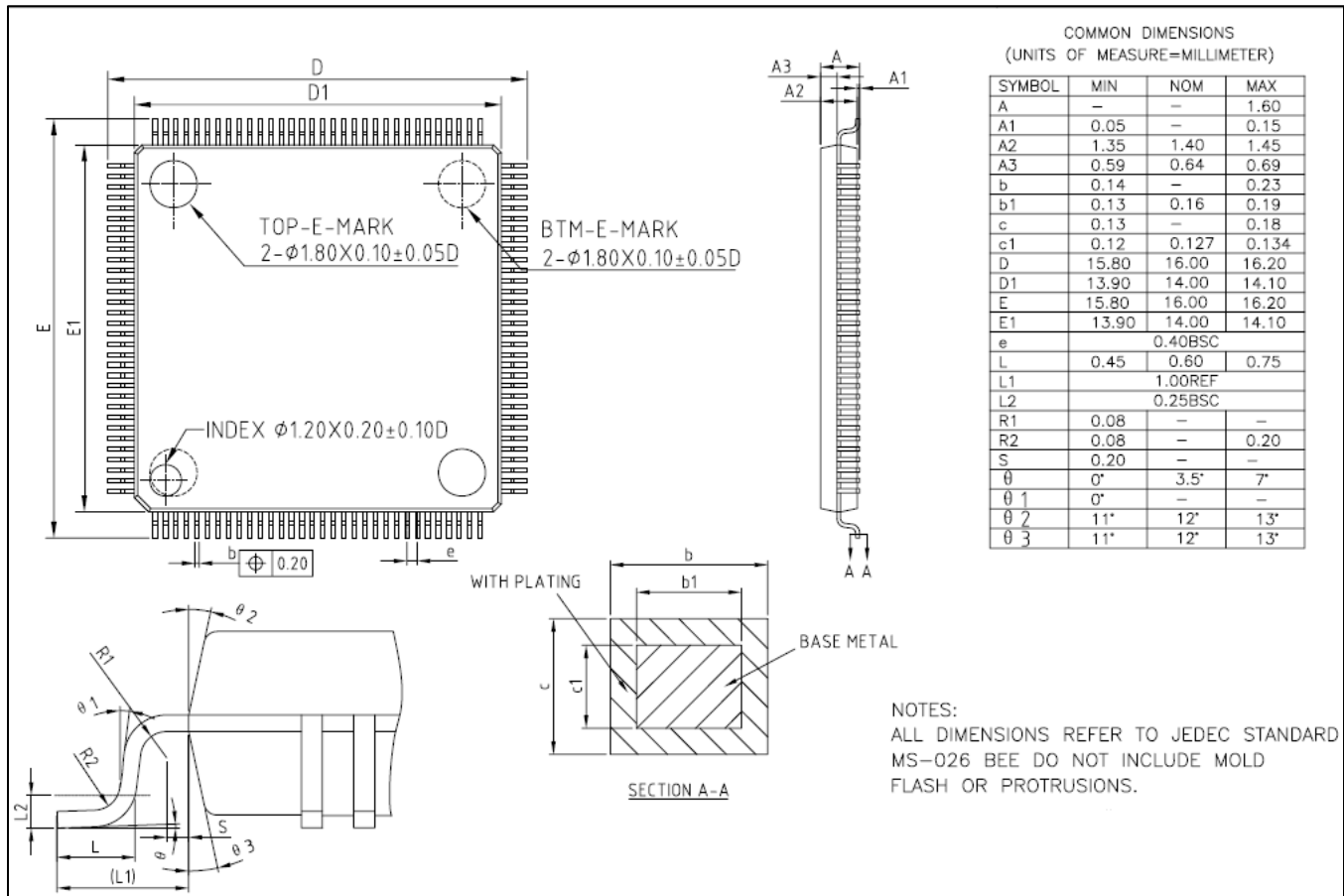
NOTES:
ALL DIMENSIONS REFER TO JEDEC STANDARD MS-026 BUT DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS.

3.4 LQFP128 Package

3.4.1 LQFP128 Pin Assignment



3.4.2 LQFP128 Package Dimensions



4 Version History

Version	Date	Changes
V1.0.0.	2020.2.12	Initial version
V1.0.1	2020.12.15	1. Modified 3.1.1, 3.4.1 pin distribution
V1.1.0	2022.7.6	1. Delete SDIO eMMC format 2. Add ETH to the resource configuration table 3. Modified reset description in Key features

5 Disclaimer

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